

## S-57A1 A Series

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# FOR AUTOMOTIVE 125°C OPERATION HIGH-WITHSTAND VOLTAGE HIGH-SPEED UNIPOLAR DETECTION TYPE HALL EFFECT SWITCH IC

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This IC, developed by CMOS technology, is a high-accuracy Hall effect switch IC that operates with high temperature and high-withstand voltage.

The output voltage changes when this IC detects the intensity level of magnetic flux density. Using this IC with a magnet makes it possible to detect the open / close and rotation status in various devices.

This IC includes a reverse voltage protection circuit and an output current limit circuit.

High-density mounting is possible by using the small SOT-23-3 package.

Due to its high-accuracy magnetic characteristics, this IC can make operation's dispersion in the system combined with magnet smaller.

ABLIC Inc. offers a "magnetic simulation service" that provides the ideal combination of magnets and our Hall effect ICs for customer systems. Our magnetic simulation service will reduce prototype production, development period and development costs. In addition, it will contribute to optimization of parts to realize high cost performance.

For more information regarding our magnetic simulation service, contact our sales office.

Caution This product can be used in vehicle equipment and in-vehicle equipment. Before using the product in the purpose, contact to ABLIC Inc. is indispensable.

#### ■ Features

• Pole detection\*1: Detection of S pole

Output logic\*1:
 Detection of N pole
 Active "L"

Active "H"

• Output form\*1: Nch open-drain output

Nch driver + built-in pull-up resistor

• Magnetic sensitivity\*1:  $B_{OP} = 3.0 \text{ mT typ.}$ • Chopping frequency:  $f_C = 250 \text{ kHz typ.}$ 

• Output delay time:  $t_D$  = 16.0  $\mu$ s typ. • Power supply voltage range:  $V_{DD}$  = 3.5 V to 26.0 V

• Built-in regulator

• Built-in reverse voltage protection circuit

• Built-in output current limit circuit

Operation temperature range:

• Lead-free (Sn 100%), halogen-free

AEC-Q100 qualified\*2

\*1. The option can be selected.

\*2. Contact our sales office for details.

# Ta = $-40^{\circ}$ C to $+125^{\circ}$ C

#### ■ Applications

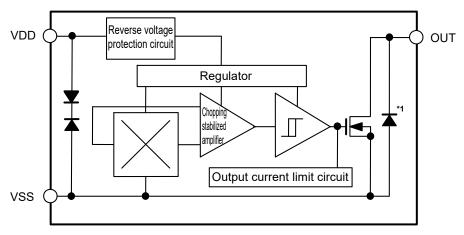
- Automobile equipment
- Home appliance
- DC brushless motor
- Housing equipment
- Industrial equipment

#### ■ Package

• SOT-23-3

#### **■** Block Diagrams

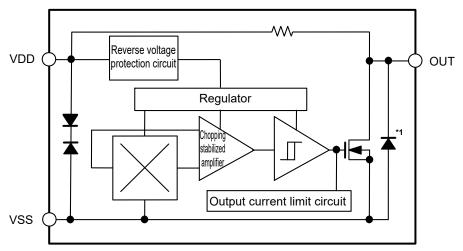
### 1. Nch open-drain output product



\*1. Parasitic diode

Figure 1

#### 2. Nch driver + built-in pull-up resistor product



\*1. Parasitic diode

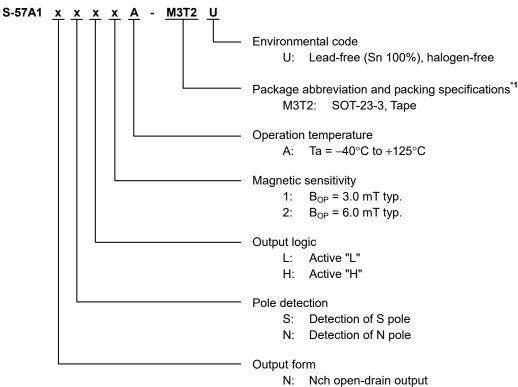
Figure 2

#### ■ AEC-Q100 Qualified

This IC supports AEC-Q100 for operation temperature grade 1. Contact our sales office for details of AEC-Q100 reliability specification.

#### **■ Product Name Structure**

#### 1. Product name



#### 2. Package

Table 1 Package Drawing Codes

| Package Name | Dimension    | Tape         | Reel         |  |
|--------------|--------------|--------------|--------------|--|
| SOT-23-3     | MP003-C-P-SD | MP003-C-C-SD | MP003-Z-R-SD |  |

#### 3. Product name list

Table 2

| Product Name      | Output Form                            | Pole Detection | Output Logic | Magnetic Sensitivity<br>(Bop) |
|-------------------|--|----------------|--------------|-------------------------------|
| S-57A1NSL1A-M3T2U | Nch open-drain output                  | S pole         | Active "L"   | 3.0 mT typ.                   |
| S-57A1NSL2A-M3T2U | Nch open-drain output                  | S pole         | Active "L"   | 6.0 mT typ.                   |
| S-57A1NSH1A-M3T2U | Nch open-drain output                  | S pole         | Active "H"   | 3.0 mT typ.                   |
| S-57A1NSH2A-M3T2U | Nch open-drain output                  | S pole         | Active "H"   | 6.0 mT typ.                   |
| S-57A1NNL1A-M3T2U | Nch open-drain output                  | N pole         | Active "L"   | 3.0 mT typ.                   |
| S-57A1NNL2A-M3T2U | Nch open-drain output                  | N pole         | Active "L"   | 6.0 mT typ.                   |
| S-57A1RSL1A-M3T2U | Nch driver + built-in pull-up resistor | S pole         | Active "L"   | 3.0 mT typ.                   |

Remark Please contact our sales office for products other than the above.

R: Nch driver + built-in pull-up resistor

<sup>\*1.</sup> Refer to the tape drawing.

#### ■ Pin Configuration

#### 1. SOT-23-3

Top view



| Pin No. | Symbol | Description      |
|---------|--------|------------------|
| 1       | VSS    | GND pin          |
| 2       | VDD    | Power supply pin |
| 3       | OUT    | Output pin       |

Table 3

Figure 3

#### ■ Absolute Maximum Ratings

Table 4

(Ta =  $+25^{\circ}$ C unless otherwise specified)

|                      |  | (: : 20 0        |                                    |      |
|----------------------|--|------------------|------------------------------------|------|
|                      | Item   | Symbol           | Absolute Maximum Rating            | Unit |
| Power supply voltage |  |                  | $V_{SS} - 28.0$ to $V_{SS} + 28.0$ | V    |
| Output current       |  | lout             | 20                                 | mA   |
| Output valtage       | Nch open-drain output product                  | V                | $V_{SS} - 0.3$ to $V_{SS} + 28.0$  | V    |
| Output voltage       | Nch driver + built-in pull-up resistor product | Vоит             | $V_{SS}-0.3$ to $V_{DD}+0.3$       | V    |
| Junction tempera     | ature  | Tj               | -40 to +150                        | °C   |
| Operation ambie      | nt temperature                                 | T <sub>opr</sub> | -40 to +125                        | °C   |
| Storage tempera      | ture   | T <sub>stg</sub> | -40 to +150                        | °C   |

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

#### **■** Thermal Resistance Value

Table 5

| Item                                     | Symbol Condition |          | on      | Min. | Тур. | Max. | Unit |
|--|------------------|----------|---------|------|------|------|------|
|  |                  |          | Board A | _    | 200  | 1    | °C/W |
|  |                  |          | Board B | _    | 165  | ı    | °C/W |
| Junction-to-ambient thermal resistance*1 | $\theta_{JA}$    | SOT-23-3 | Board C | -    | 1    | 1    | °C/W |
|  |                  |          | Board D | _    | I    | I    | °C/W |
|  |                  |          | Board E | _    | ı    | 1    | °C/W |

<sup>\*1.</sup> Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ Power Dissipation" and "Test Board" for details.

#### **■** Electrical Characteristics

Table 6

(Ta = +25°C, V<sub>DD</sub> = 12.0 V, V<sub>SS</sub> = 0 V unless otherwise specified)

| Item                      | Symbol            | Condition   | Min. | Тур. | Max. | Unit | Test<br>Circuit |
|---------------------------|-------------------|---|------|------|------|------|-----------------|
| Power supply voltage      | $V_{DD}$          | -   | 3.5  | 12.0 | 26.0 | V    | _               |
| Current consumption       | Ipp               | Nch open-drain output product Average value   | _    | 3.0  | 4.0  | mA   | 1               |
| Current consumption       | מטו               | Nch driver + built-in pull-up resistor product<br>Average value, V <sub>OUT</sub> = "H"                     | -    | 3.0  | 4.0  | mA   | 1               |
| Current consumption       | I                 | Nch open-drain output product $V_{DD} = -26.0 \text{ V}$  | -1   | ı    |      | mA   | 1               |
| during reverse connection | Iddrev            | Nch driver + built-in pull-up resistor product $V_{DD} = -26.0 \text{ V}$                                   | -5   | ı    |      | mA   | 1               |
| Output voltage            | Vоит              | Nch open-drain output product Output transistor Nch, V <sub>OUT</sub> = "L", I <sub>OUT</sub> = 10 mA       | -    | -    | 0.4  | V    | 2               |
| Output voltage            | <b>V</b> 001      | Nch driver + built-in pull-up resistor product<br>Output transistor Nch, $V_{OUT}$ = "L", $I_{OUT}$ = 10 mA | _    | -    | 0.5  | V    | 2               |
| Output drop voltage       | V <sub>D</sub>    | Nch driver + built-in pull-up resistor product<br>$V_{OUT}$ = "H", $V_D$ = $V_{DD}$ - $V_{OUT}$             | -    | ı    | 20   | mV   | 2               |
| Leakage current           | I <sub>LEAK</sub> | Nch open-drain output product<br>Output transistor Nch, V <sub>OUT</sub> = "H" = 26.0 V                     | -    | -    | 10   | μΑ   | 3               |
| Output limit current      | Іом               | V <sub>OUT</sub> = 12.0 V   | 22   | _    | 70   | mA   | 3               |
| Output delay time         | t <sub>D</sub>    | _   | _    | 16.0 | _    | μs   | _               |
| Chopping frequency        | fc                | _   | _    | 250  | _    | kHz  | _               |
| Start up time             | t <sub>PON</sub>  | _   | _    | 30   | _    | μs   | 4               |
| Output rise time          | to                | Nch open-drain output product $C = 20 \text{ pF}, R = 820 \Omega$   | -    | _    | 2.0  | μs   | 5               |
| Output rise time          | t <sub>R</sub>    | Nch driver + built-in pull-up resistor product<br>C = 20 pF   | -    | -    | 6.0  | μs   | 5               |
| Output fall time          | t <sub>F</sub>    | C = 20 pF, R = 820 Ω  | _    |      | 2.0  | μs   | 5               |
| Pull-up resistor          | RL                | Nch driver + built-in pull-up resistor product  | 7    | 10   | 13   | kΩ   | _               |

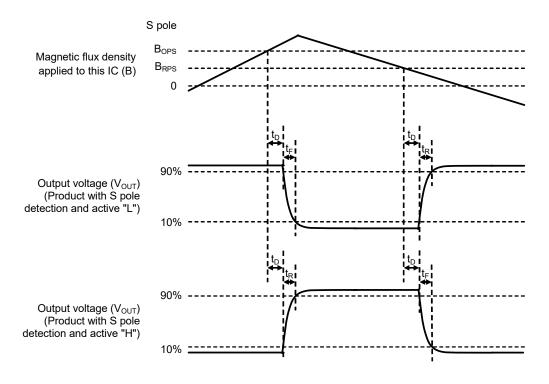


Figure 4 Operation Timing

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#### ■ Magnetic Characteristics

#### 1. Product with S pole detection

#### 1. 1 Product with $B_{OP} = 3.0 \text{ mT typ.}$

#### Table 7

(Ta = +25°C, V<sub>DD</sub> = 12.0 V, V<sub>SS</sub> = 0 V unless otherwise specified)

| Item               |        | Symbol            | Condition  | Min. | Тур. | Max. | Unit | Test Circuit |
|--------------------|--------|-------------------|--|------|------|------|------|--------------|
| Operation point*1  | S pole | Bops              | _  | 1.5  | 3.0  | 4.5  | mT   | 4            |
| Release point*2    | S pole | B <sub>RPS</sub>  | _  | 1.0  | 2.0  | 3.3  | mT   | 4            |
| Hysteresis width*3 | S pole | B <sub>HYSS</sub> | B <sub>H</sub> YSS = B <sub>O</sub> PS - B <sub>R</sub> PS | 1    | 1.0  | 1    | mT   | 4            |

#### 1. 2 Product with $B_{OP} = 6.0 \text{ mT typ.}$

#### Table 8

(Ta = +25°C, V<sub>DD</sub> = 12.0 V, V<sub>SS</sub> = 0 V unless otherwise specified)

| Item               |        | Symbol             | Condition   | Min. | Тур. | Max. | Unit | Test Circuit |
|--------------------|--------|--------------------|---|------|------|------|------|--------------|
| Operation point*1  | S pole | Bops               | _   | 3.0  | 6.0  | 9.0  | mT   | 4            |
| Release point*2    | S pole | B <sub>RPS</sub>   | _   | 2.5  | 4.5  | 7.5  | mT   | 4            |
| Hysteresis width*3 | S pole | B <sub>H</sub> YSS | B <sub>HYSS</sub> = B <sub>OPS</sub> - B <sub>RPS</sub> | _    | 1.5  | _    | mT   | 4            |

#### 2. Product with N pole detection

#### 2. 1 Product with $B_{OP} = 3.0 \text{ mT typ.}$

#### Table 9

(Ta = +25°C, V<sub>DD</sub> = 12.0 V, V<sub>SS</sub> = 0 V unless otherwise specified)

| Item               |        | Symbol           | Condition           | Min. | Тур. | Max. | Unit | Test Circuit |
|--------------------|--------|------------------|---------------------|------|------|------|------|--------------|
| Operation point*1  | N pole | Bopn             | _                   | -4.5 | -3.0 | -1.5 | mT   | 4            |
| Release point*2    | N pole | B <sub>RPN</sub> | _                   | -3.3 | -2.0 | -1.0 | mT   | 4            |
| Hysteresis width*3 | N pole | BHYSN            | BHYSN = BOPN - BRPN | I    | 1.0  | ı    | mT   | 4            |

#### 2. 2 Product with Bop = 6.0 mT typ.

#### Table 10

(Ta = +25°C, V<sub>DD</sub> = 12.0 V, V<sub>SS</sub> = 0 V unless otherwise specified)

| Item               |        | Symbol           | Condition   | Min. | Тур. | Max. | Unit | Test Circuit |
|--------------------|--------|------------------|---|------|------|------|------|--------------|
| Operation point*1  | N pole | BOPN             | _   | -9.0 | -6.0 | -3.0 | mT   | 4            |
| Release point*2    | N pole | B <sub>RPN</sub> | _   | -7.5 | -4.5 | -2.5 | mT   | 4            |
| Hysteresis width*3 | N pole | BHYSN            | B <sub>H</sub> YSN =  B <sub>OPN</sub> - B <sub>RPN</sub> | -    | 1.5  | I    | mT   | 4            |

#### \*1. Bopn, Bops: Operation points

 $B_{OPN}$  and  $B_{OPS}$  are the values of magnetic flux density when the output voltage ( $V_{OUT}$ ) changes after the magnetic flux density applied to this IC by the magnet (N pole or S pole) is increased (by moving the magnet closer).

Even when the magnetic flux density exceeds  $B_{\text{OPN}}$  or  $B_{\text{OPS}}$ ,  $V_{\text{OUT}}$  retains the status.

#### \*2. BRPN, BRPS: Release points

 $B_{RPN}$  and  $B_{RPS}$  are the values of magnetic flux density when the output voltage ( $V_{OUT}$ ) changes after the magnetic flux density applied to this IC by the magnet (N pole or S pole) is decreased (the magnet is moved further away).

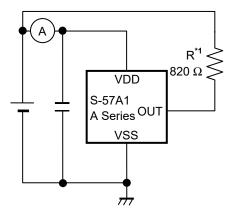
Even when the magnetic flux density falls below BRPN or BRPS, VOUT retains the status.

#### \*3. BHYSN, BHYSS: Hysteresis widths

BHYSN and BHYSS are the difference between BOPN and BRPN, and BOPS and BRPS, respectively.

Remark The unit of magnetic density mT can be converted by using the formula 1 mT = 10 Gauss.

#### **■** Test Circuits



\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 5 Test Circuit 1

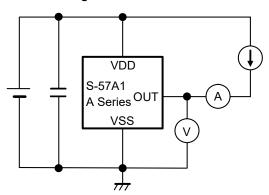


Figure 6 Test Circuit 2

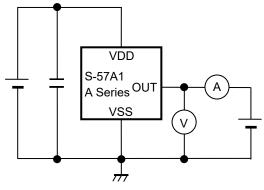
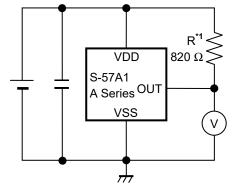
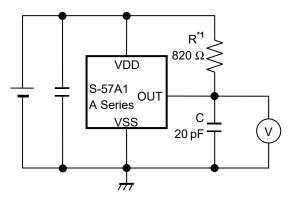


Figure 7 Test Circuit 3



\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

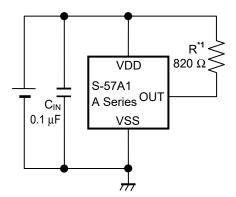
Figure 8 Test Circuit 4



\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 9 Test Circuit 5

#### **■** Standard Circuit



\*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 10

Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

#### ■ Operation

#### 1. Direction of applied magnetic flux

This IC detects the magnetic flux density which is vertical to the marking surface.

Figure 11 shows the direction in which magnetic flux is being applied.

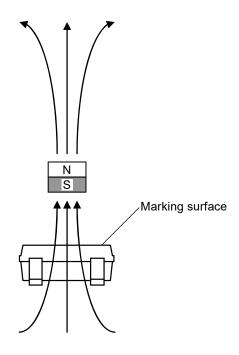


Figure 11

#### 2. Position of Hall sensor

Figure 12 shows the position of Hall sensor.

The center of this Hall sensor is located in the area indicated by a circle, which is in the center of a package as described below.

The following also shows the distance (typ. value) between the marking surface and the chip surface of a package.

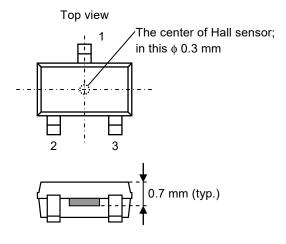


Figure 12

#### 3. Basic operation

This IC changes the output voltage  $(V_{OUT})$  according to the level of the magnetic flux density (N pole or S pole) applied by a magnet.

The following explains the operation when the output logic is active "L".

#### 3. 1 Product with S pole detection

When the magnetic flux density of the S pole perpendicular to the marking surface exceeds the operation point (BoPS) after the S pole of a magnet is moved closer to the marking surface of this IC, VoUT changes from "H" to "L". When the S pole of a magnet is moved further away from the marking surface of this IC and the magnetic flux density is lower than the release point (BRPS), VoUT changes from "L" to "H".

Figure 13 shows the relationship between the magnetic flux density and V<sub>OUT</sub>.

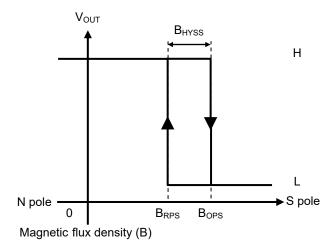


Figure 13

#### 3. 2 Product with N pole detection

When the magnetic flux density of the N pole perpendicular to the marking surface exceeds the operation point ( $B_{OPN}$ ) after the N pole of a magnet is moved closer to the marking surface of this IC,  $V_{OUT}$  changes from "H" to "L". When the N pole of a magnet is moved further away from the marking surface of this IC and the magnetic flux density of the N pole is lower than the release point ( $B_{RPN}$ ),  $V_{OUT}$  changes from "L" to "H".

Figure 14 shows the relationship between the magnetic flux density and V<sub>OUT</sub>.

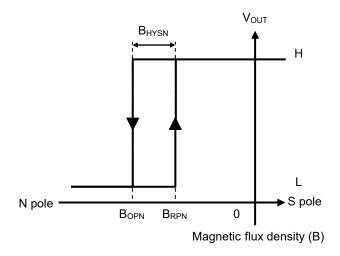


Figure 14

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#### 4. Timing chart

Figure 15 shows the operation timing at power-on.

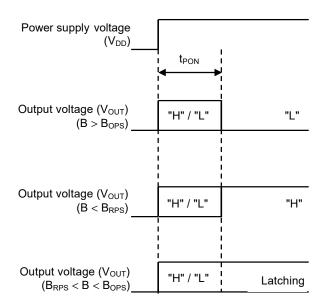
The initial output voltage at rising of power supply voltage (V<sub>DD</sub>) is either "H" or "L".

In case of B > B<sub>OPS</sub> or B < B<sub>RPS</sub> at the time when the start up time ( $t_{PON}$ ) is passed after rising of V<sub>DD</sub>, this IC outputs V<sub>OUT</sub> according to the applied magnetic flux density.

In case of  $B_{RPS} < B < B_{OPS}$  at the time when  $t_{PON}$  is passed after rising of  $V_{DD}$ , this IC maintains the initial output voltage.

#### Product with S pole detection and active "L"

#### Product with S pole detection and active "H"



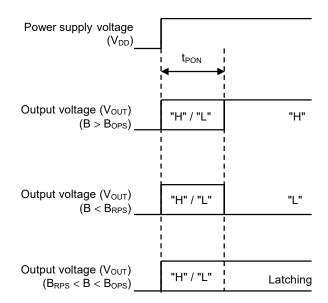


Figure 15

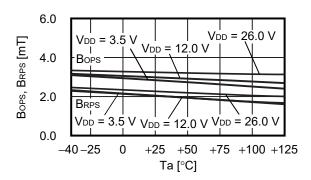
#### ■ Precautions

- If the impedance of the power supply is high, the IC may malfunction due to a supply voltage drop caused by feedthrough current. Take care with the pattern wiring to ensure that the impedance of the power supply is low.
- Note that the IC may malfunction if the power supply voltage rapidly changes. When the IC is used under the environment where the power supply voltage rapidly changes, it is recommended to judge the output voltage of the IC by reading it multiple times.
- Note that the output voltage may rarely change if the magnetic flux density between the operation point and the release point is applied to this IC continuously for a long time.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- Although this IC has a built-in output current limit circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- Although this IC has a built-in reverse voltage protection circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- The application conditions for the power supply voltage, the pull-up voltage, and the pull-up resistor should not exceed the power dissipation.
- Large stress on this IC may affect the magnetic characteristics. Avoid large stress which is caused by the handling during or after mounting the IC on a board.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

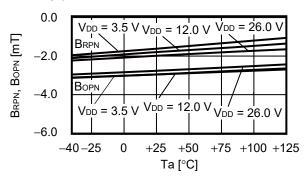
#### ■ Characteristics (Typical Data)

#### 1. Operation point, release point (Bop, BRP) vs. Temperature (Ta)

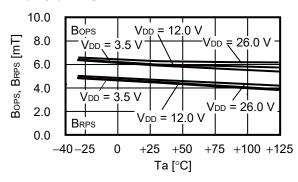
#### 1.1 S-57A1xSx1A



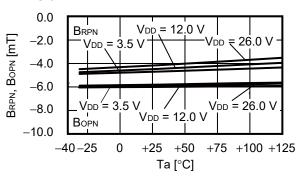
#### 1. 2 S-57A1xNx1A



#### 1. 3 S-57A1xSx2A

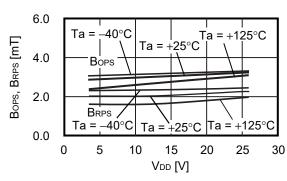


#### 1. 4 S-57A1xNx2A

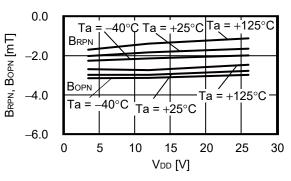


#### 2. Operation point, release point (Bop, BRP) vs. Power supply voltage (VDD)

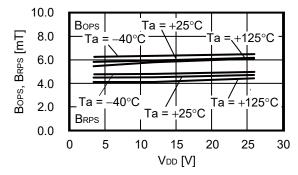
#### 2. 1 S-57A1xSx1A



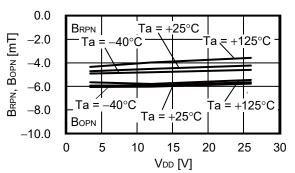
#### 2. 2 S-57A1xNx1A



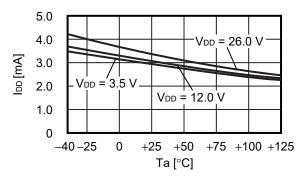
#### 2. 3 S-57A1xSx2A



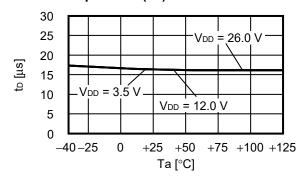
#### 2. 4 S-57A1xNx2A



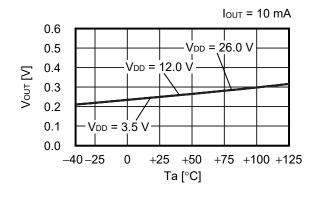
# 3. Current consumption (I<sub>DD</sub>) vs. Temperature (Ta)



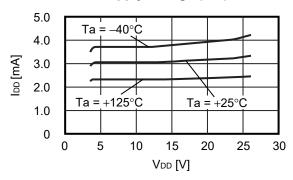
# 5. Output delay time (t<sub>D</sub>) vs. Temperature (Ta)



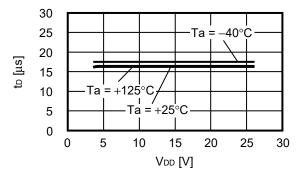
#### 7. Output voltage (V<sub>OUT</sub>) vs. Temperature (Ta)



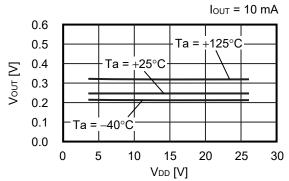
# 4. Current consumption (I<sub>DD</sub>) vs. Power supply voltage (V<sub>DD</sub>)



# 6. Output delay time (t<sub>D</sub>) vs. Power supply voltage (V<sub>DD</sub>)

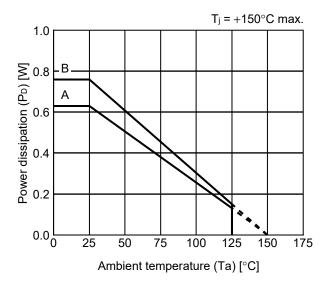


# 8. Output voltage (V<sub>OUT</sub>) vs. Power supply voltage (V<sub>DD</sub>)



### **■** Power Dissipation

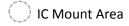
#### SOT-23-3

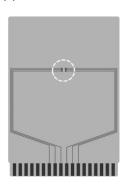


| Board | Power Dissipation (P <sub>D</sub> ) |
|-------|-------------------------------------|
| Α     | 0.63 W                              |
| В     | 0.76 W                              |
| С     | -                                   |
| D     | -                                   |
| Е     | _                                   |

# **SOT-23-3/3S/5/6** Test Board

### (1) Board A





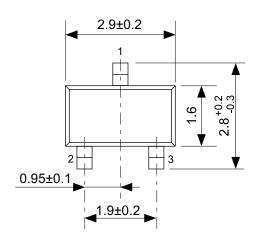
| Item                        |   | Specification                               |
|-----------------------------|---|---|
| Size [mm]                   |   | 114.3 x 76.2 x t1.6                         |
| Material                    |   | FR-4  |
| Number of copper foil layer |   | 2   |
|                             | 1 | Land pattern and wiring for testing: t0.070 |
| Copper foil layer [mm]      | 2 | -   |
| Copper foil layer [min]     | 3 | -   |
|                             | 4 | 74.2 x 74.2 x t0.070                        |
| Thermal via                 |   | -   |

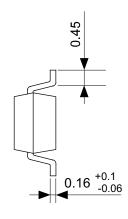
### (2) Board B

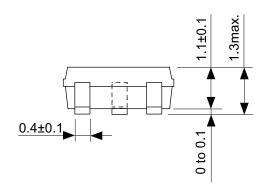


| Item                        |   | Specification                               |  |
|-----------------------------|---|---|--|
| Size [mm]                   |   | 114.3 x 76.2 x t1.6                         |  |
| Material                    |   | FR-4  |  |
| Number of copper foil layer |   | 4   |  |
| Copper foil layer [mm]      | 1 | Land pattern and wiring for testing: t0.070 |  |
|                             | 2 | 74.2 x 74.2 x t0.035                        |  |
|                             | 3 | 74.2 x 74.2 x t0.035                        |  |
|                             | 4 | 74.2 x 74.2 x t0.070                        |  |
| Thermal via                 |   | -   |  |

No. SOT23x-A-Board-SD-2.0

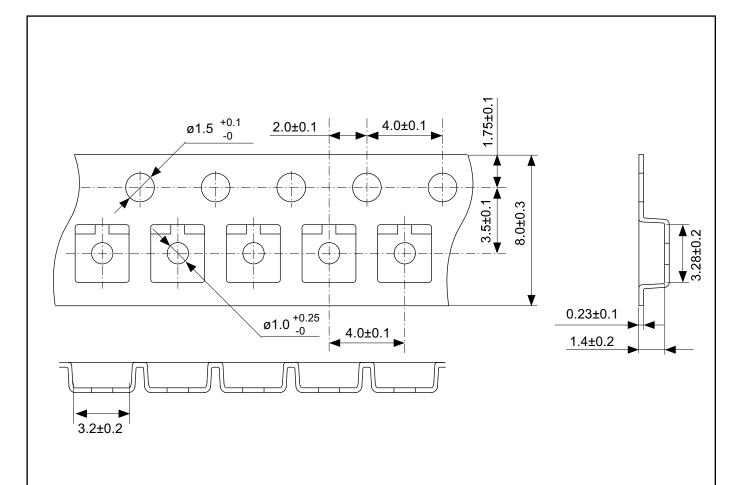


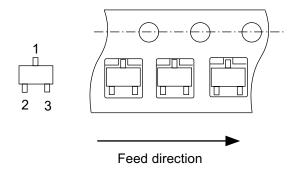




No. MP003-C-P-SD-1.1

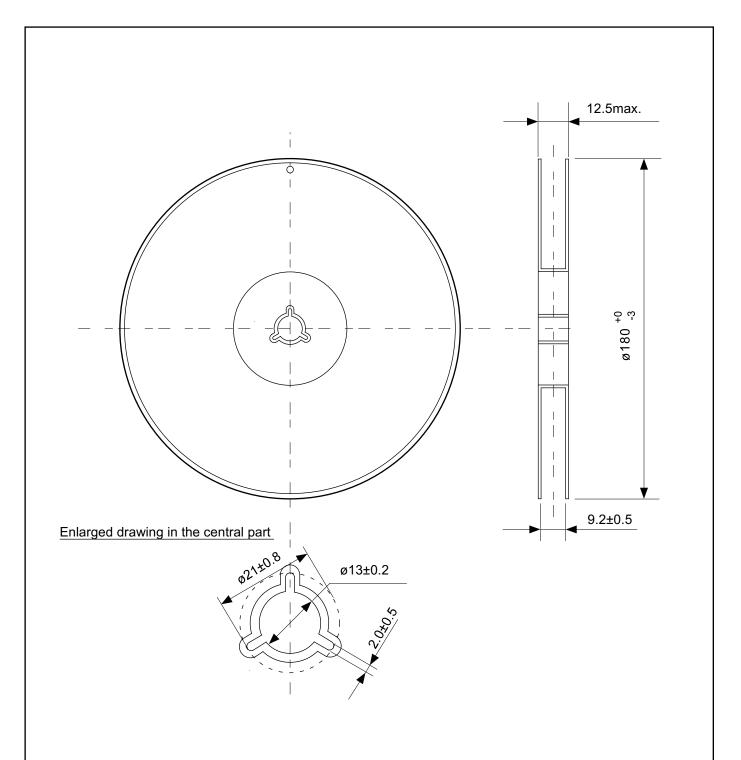
| TITLE          | SOT233-C-PKG Dimensions |  |  |  |  |
|----------------|-------------------------|--|--|--|--|
| No.            | MP003-C-P-SD-1.1        |  |  |  |  |
| ANGLE          | <b>⊕</b> € 1            |  |  |  |  |
| UNIT           | mm                      |  |  |  |  |
|                |                         |  |  |  |  |
|                |                         |  |  |  |  |
|                |                         |  |  |  |  |
| A DI I C. In a |                         |  |  |  |  |
| ABLIC Inc.     |                         |  |  |  |  |





### No. MP003-C-C-SD-2.0

| TITLE       | SOT233-C-Carrier Tape |  |  |  |  |
|-------------|-----------------------|--|--|--|--|
| No.         | MP003-C-C-SD-2.0      |  |  |  |  |
| ANGLE       |                       |  |  |  |  |
| UNIT        | mm                    |  |  |  |  |
|             |                       |  |  |  |  |
|             |                       |  |  |  |  |
|             |                       |  |  |  |  |
| ABLIC Inc.  |                       |  |  |  |  |
| ADEIO IIIC. |                       |  |  |  |  |



# No. MP003-Z-R-SD-1.0

| TITLE      | SOT233-C-Reel    |      |       |  |  |
|------------|------------------|------|-------|--|--|
| No.        | MP003-Z-R-SD-1.0 |      |       |  |  |
| ANGLE      |                  | QTY. | 3,000 |  |  |
| UNIT       | mm               |      |       |  |  |
|            |                  |      |       |  |  |
|            |                  |      |       |  |  |
|            |                  |      |       |  |  |
| ABLIC Inc. |                  |      |       |  |  |

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